

Position-sensitive device

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1. Introduction

We define a position-sensitive device as a device that converts the center of mass of an input optical signal into an electrical output. The present document is meant to summarize the theory required to design such a position-sensitive device.

1.1. Document overview

This document is organized as follows. The first section gives an overview of the design requirements imposed upon our position-sensitive device. In the second section, we summarize the physical theory behind the position-sensitive detector and discuss its electrical properties. In the third section, we dive into the theory of operational amplifier as a front-end for the position-sensitive detector.

1.2. Target audience

1.3. Typical applications

Position-sensitive devices are used in a wide range of industrial and commercial applications, including displacement sensing and beam alignment, see Ref. [1, p. 22]. In our case, we were interested in the application of the position-sensitive device for beam pointing alignment. Beam pointing refers to the spatial focus of a laser beam and can change through, for instance, thermal and mechanical effects. Uncompensated changes in beam alignment can quickly degrade the overall performance of an optical system. It is, therefore, crucial to align the beam pointing to ensure proper operation of the optical system at hand. Using a position-sensitive device for monitoring the beam pointing as part of a feedback loop, would allow for automatization of this otherwise cumbersome work.

2. Specification

The device should be powered by a dual voltage supply of 15 V using a 4 pin LEMO connector. The components on the printed circuit board should be assembled using surface-mount technology. The device including casing should have a width below 8 cm and a height below 20 cm, preferably smaller, such that it can be integrated easily into existing optical setups. The optical detector should be located as close to the bottom of the device as possible, as it allows greater height compatibility.

The spatial resolution of the center of mass of the incident light should be about 1 μm . Offset errors are tolerable as long as precision is high. We aim for a signal bandwidth of 10 kHz. The radiant flux of the incident light should be in the microwatt range.

2.1. Precision and accuracy

2.2. Connectors

3. Circuit schematic

3.1. Power management

3.1.1. Supply filter

The purpose of the supply filter is to filter out noise from the power supply and buffer voltage peaks. A simple embodiment of a supply filter is that of an RC low-pass filter as illustrated in Figure 1.

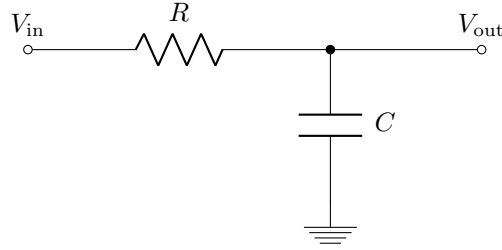


Figure 1: Passive low-pass filter using an RC circuit.

In Figure 1 the input voltage is connected through a resistor R with the output voltage. After the resistor R , a capacitor C is connected with ground. The transfer function of the RC low-pass filter can be obtained from the voltage divider with complex impedances,

$$\frac{V_{out}}{V_{in}} = \frac{Z_C}{Z_R + Z_C} = \frac{1}{1 + j\omega RC}. \quad (1)$$

The absolute value of the transfer function,

$$\left| \frac{V_{out}}{V_{in}} \right| = \frac{1}{\sqrt{1 + (f/f_{RC})^2}}, \quad (2)$$

has a pole at frequency,

$$f_{RC} = \frac{1}{2\pi RC}. \quad (3)$$

The frequency response of an RC low-pass with pole frequency $f_{RC} = 100$ Hz is visualized in Figure 2.

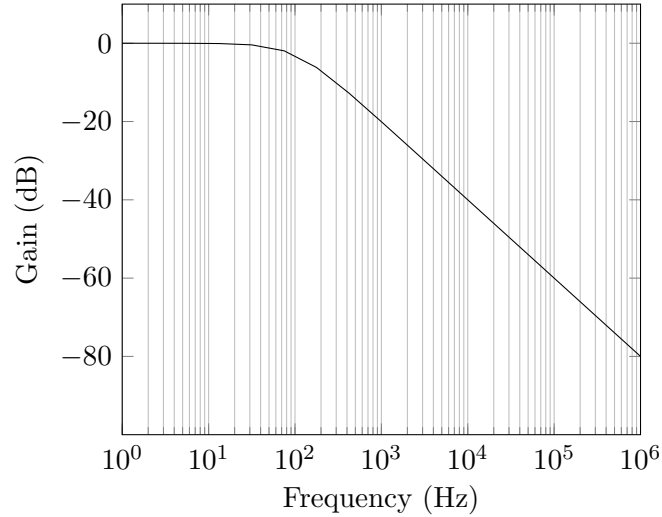


Figure 2: Bode plot of the frequency response of an RC low-pass at 100 Hz.

We can see how the frequency response suppresses frequency above 100 Hz. However, efficient frequency suppression starts at -80 dB which the given RC low-pass of Figure 2 only satisfies for much higher frequencies than the pole frequency.

One approach to improve the frequency response of a filter is to introduce additional frequency poles. In the limit of infinite many frequency poles, one is able to approach an ideal brick-wall filter. The frequency response of an ideal brick-wall filter resembles a step function. In practice, one finds good enough results for two pole filters.

In addition to a multi-pole filter, a capacitance multiplier can be used to increase the effective capacitance of a filter. The capacitance multiplier is described in Ref. [2, p. 536] and Ref. [3, p. 578].

3.1.2. Voltage regulator

We use two voltage regulator to maintain a constant voltage of ± 12 V which is used to supply the operational amplifiers.

In general, one needs to decide between linear and switching voltage regulators. Linear voltage regulators are less efficient than their switching counterparts but have better noise characteristics. As efficiency is not a concern in our application, the better noise characteristics are a strong argument for the linear voltage regulators. Linear voltage regulators require an input voltage greater than the output voltage. The difference

between input and output voltage is called the drop-out voltage. The drop-out voltage is about 2 V to 3 V

Linear voltage regulators are available with fixed and adjustable output voltage. As we might need an additional voltage drop between the input voltage and the voltage regulator input, e.g. for input power filters, an adjustable voltage regulator would allow for more flexibility. Moreover, we found the range of negative voltage regulators to be rather limited.

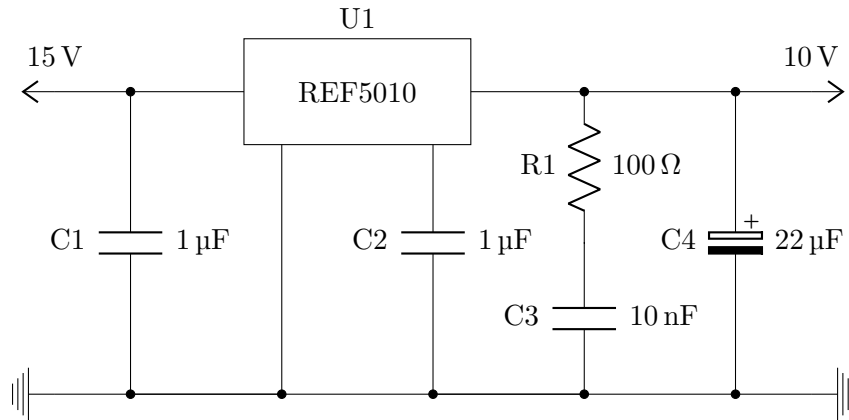


Figure 3: Dual supply voltage regulator.

Figure 3 illustrates the schematic of the final dual voltage regulator supply circuit. The input voltage is buffered by capacitors C1 and C2. U1 and U2 denote the fixed positive and negative voltage regulators. Resistors R1 and R2 configure the output voltage of U1 to about +11.5 V. Resistors R3 and R4 configure the output voltage of U2 to about −11.5 V. Capacitors C3, C4, C5 and C6 buffer the output voltage. When the supply power is switched off and C3 or C5 discharges, diodes D3 and D1 redirect the current back to the supply lines around the voltage regulators.

3.1.3. Voltage reference

A voltage reference is a high-precision linear (fixed) voltage regulator. We use it as a voltage source for the sensible reverse bias voltage of the photodiode.

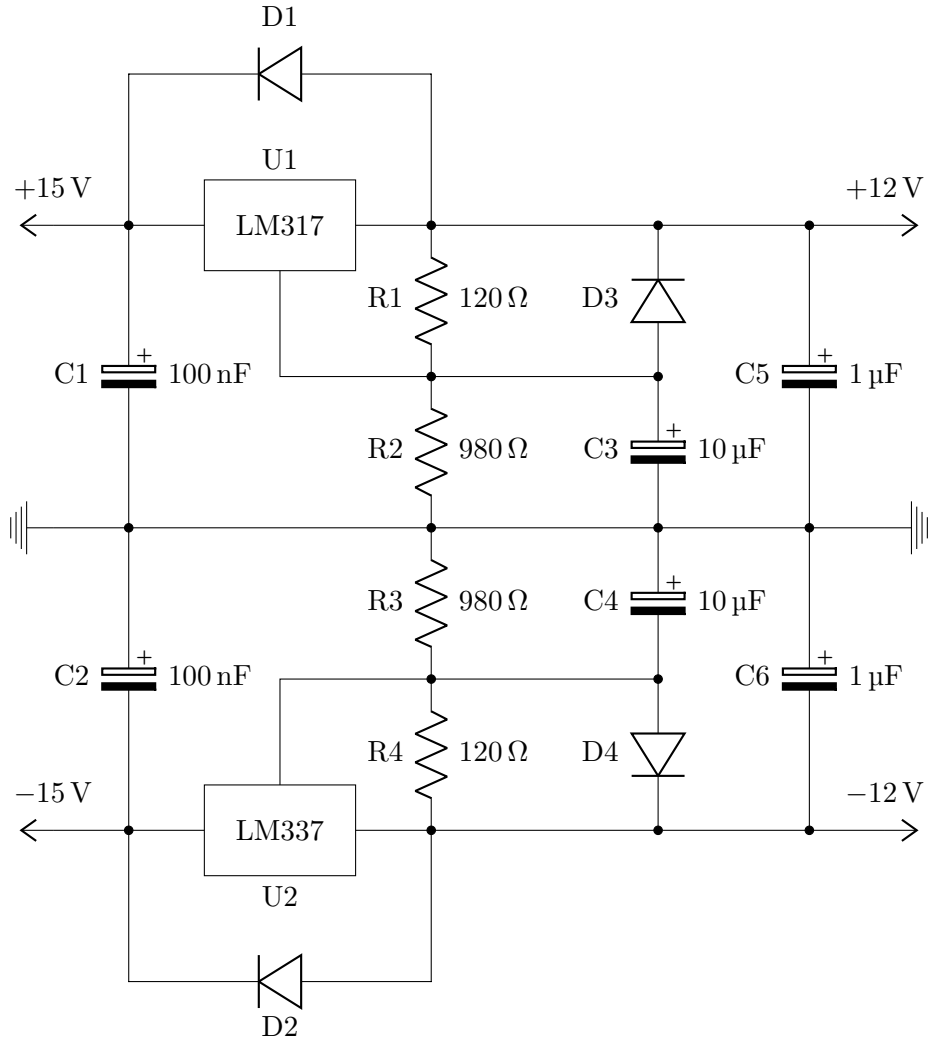


Figure 4: High-precision voltage reference.

Figure 4 depicts the schematic of the voltage reference circuit. Capacitor C1 buffers the 15 V supply voltage. According to the datasheet the trim terminal should be connected through a capacitor, C2, to ground. Resistor R1 and capacitor C3 form a low-pass to suppress frequency components in the kHz range. Finally, capacitor C4 buffers the output voltage.

3.2. Photodiode frontend

4. Bill of materials

5. Printed circuit board

6. Manufacturing

7. Commissioning

A. Theory of linear filter

B. Theory of photodiode operation

B.1. Transverse photodiodes

The purpose of the following section is to recall the mechanics of the (transverse) photoeffect observed in an illuminated p-n junction. Figures and the description thereof is largely based on Ref. [4]. A subtle difference in the depicted figures and the figures of Ref. [4] is that we exchanged the order of p- and n-type semiconductors. We found this order to be more intuitive when referring to a p-n junction.

Figure 5 shows a separated p- and n-type semiconductor. In the upper half, we see an illustration of the p- and n-type semiconductor with their respective mobile charge carriers. The p-type semiconductor has an excess of positive charge carriers (holes) which are depicted as white circles. The n-type semiconductor has an excess of negative charge carriers (electrons) which are depicted as black circles. The excess charge carriers form due to the implantation of acceptor and donator ions. These are depicted as circles with plus and minus sign in Figure 5. The implanted ions have more or fewer electrons than the atoms of the semiconductor material. Therefore donating an electron or accepting an electron and effectively forming a hole as an absence of negative charge.

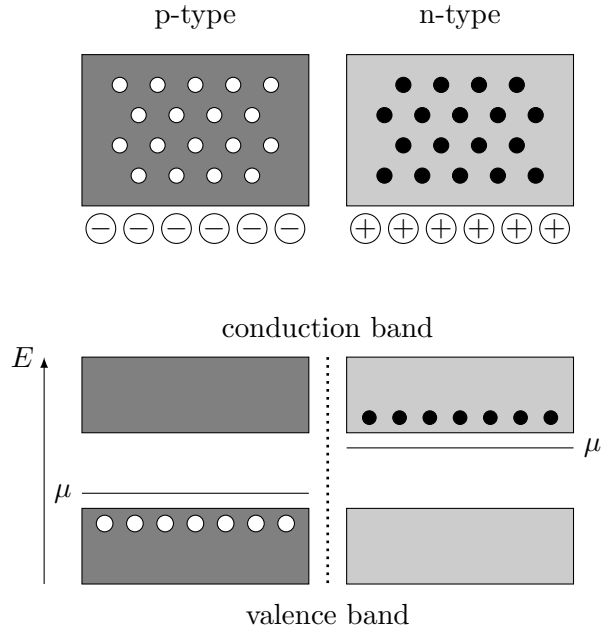


Figure 5: Separated p- and n-type semiconductor with holes (white) and electrons (black).

The lower half of Figure 5 shows the energy band structure of both p- and n-type semiconductor. The lower energy band represents the valence band made up of the electrons that are tightly bound to a single atomic core. The upper energy band represents the conduction band made up of electrons that are not bound to a single atomic core but shared across the lattice. Charge carriers in the conduction band can move freely and thereby contribute to the conductivity of the material. For an undoped (intrinsic) semiconductor the chemical potential is in the center of the band gap between the conduction and valence band. Through doping, the chemical potential is shifted in the p- and n-type semiconductor. In the p-type semiconductor, acceptor ions can take up electrons from the conduction band, thereby decreasing the chemical potential. In the n-type semiconductor, donor ions contribute electrons to the conduction band, thereby increasing the chemical potential.

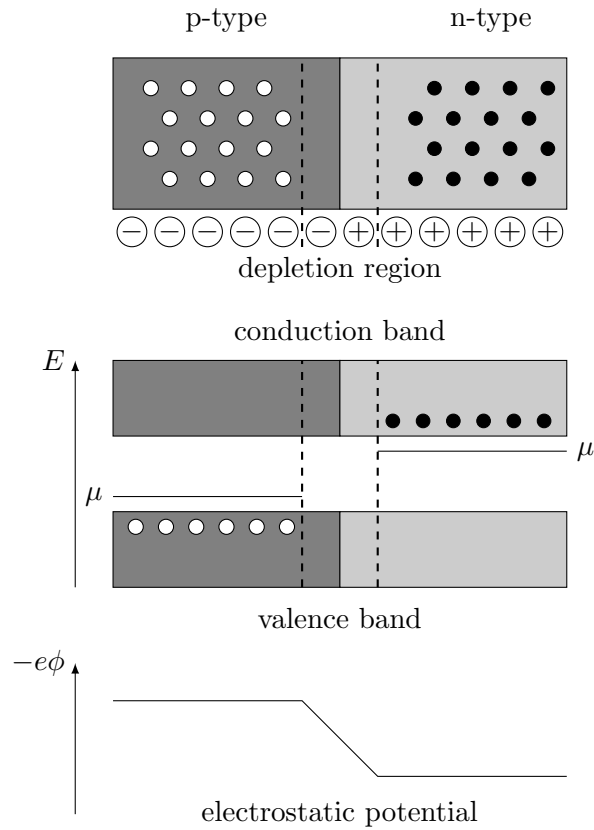


Figure 6: Combined p- and n-type semiconductor with holes (white) and electrons (black).

In Figure 6 the p- and n-type semiconductor are brought into contact with each other, forming a p-n junction. In close proximity of the junction holes and electrons recombine due to a diffusion process, leaving an electrically charged area. The electrically charged

area creates an electrostatic potential across the junction as illustrated in the lower part of Figure 6. We refer to this area as the depletion region. In Figure 6 the depletion region expands between the dashed lines around the junction.

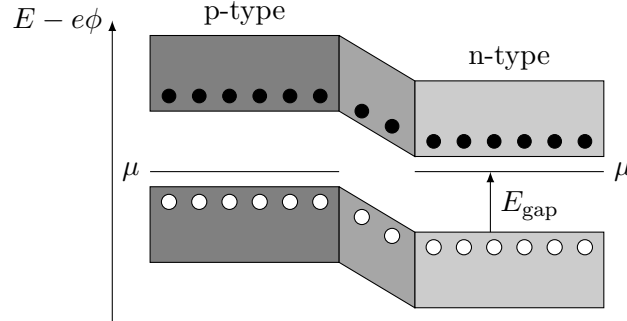


Figure 7: Energy bands of the p-n junction.

The energy band diagram in Figure 7 accounts for the shift in energy due to the electrostatic potential. The chemical potentials of both sides of the junction are now aligned. The energy required to excite an electron on the p-type side from the valence to the conduction band and the energy required to excite a hole from the conduction to the valence band are equal to the band gap of the semiconductor.

If one applies a reverse bias voltage across the p-n junction, the effective energy gap between conduction and valence band is reduced, the electrostatic potential increases and the depletion region broadens. The situation of an applied reverse voltage is depicted in Figure 8.

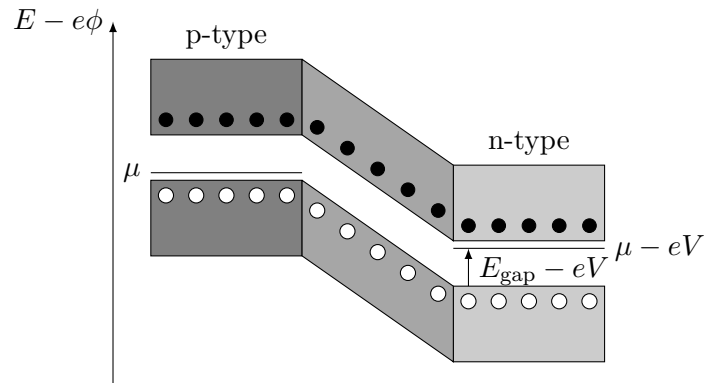


Figure 8: Energy band diagram of a reverse biased p-n junction.

The current-voltage characteristic of the p-n junction is described by the Shockley diode

equation,

$$I_{\text{diode}} = I_{\text{sat}}(T) \left(e^{eV/k_B T} - 1 \right), \quad (4)$$

wherein $I_{\text{sat}} \propto e^{-E_{\text{gap}}/k_B T}$ is the temperature dependent reverse bias saturation current and V the voltage applied to the p-n junction. Using the proportionality of the reverse bias saturation current, we can write,

$$I_{\text{diode}} \propto e^{(eV - E_{\text{gap}})/k_B T} - e^{-E_{\text{gap}}/k_B T}, \quad (5)$$

which discloses the two effects contributing to the diode current. The left-hand side of the proportionality of Equation (5) represents the current contribution due intra-band excitation of charge carriers, whereas the right-hand side represents the current contribution due to inter-band excitation.

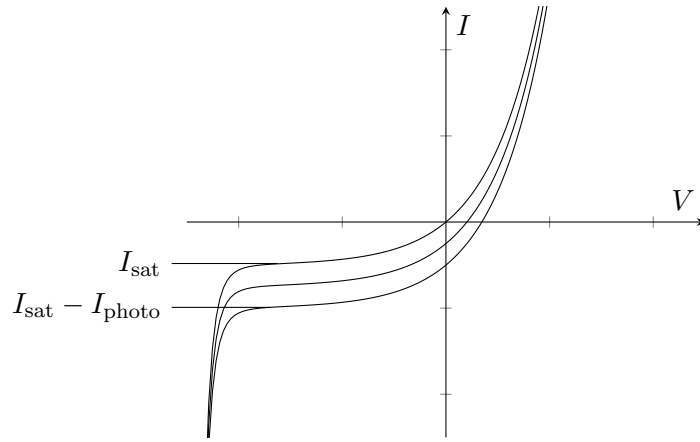


Figure 9: Current-voltage characteristics of a p-n junction with different levels of illumination.

In Figure 9 we see the current-voltage characteristics of the p-n junction under different levels of illumination. For negative voltages, the p-n junction is operated under reverse bias. If the reverse bias voltage exceeds the breakdown voltage the p-n junction starts to conduct. The current before the breakdown occurs is the reverse saturation current. For different levels of illumination, the curve is shifted downwards. The separation between the non-illuminated (top curve) and illuminated curves represent the respective photocurrent.

The conversion rate of photons to photoelectrons depends on the type of the band gap, i.e. direct or indirect, the wavelength λ of the photon and the temperature T . Most photodiodes report a wavelength λ dependent responsivity R which can be used to convert the radiant flux P of the incident light to the generated photocurrent I_{photo} ,

$$I_{\text{photo}} = R(\lambda)P. \quad (6)$$

For silicon-based p-n junctions, the responsivity $R(\lambda)$ is between 0.2 A W^{-1} at 400 nm and 0.6 A W^{-1} at 950 nm.

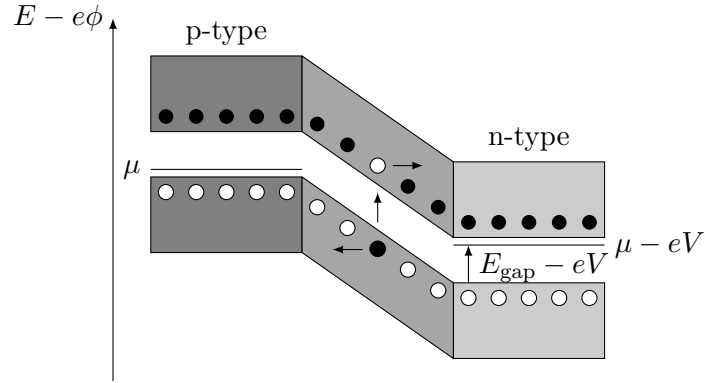


Figure 10: Energy diagram of a reverse biased p-n junction under illumination.

Figure 10 shows a p-n junction under reverse bias where a photon excites an electron-hole pair in the depletion region. Due to the electrostatic potential, the electron is accelerated to the right side. Analogue the hole is accelerated to the left side and in addition to the diode current, Equation (4), a photocurrent can be measured across the junction.

B.2. Lateral photodiodes

In the previous section, we discussed the transversal photoeffect that is usually associated with the illumination of the p-n junction. In addition to the transversal photoeffect, the lateral photoeffect was first discovered by W. Schottky [5] in 1930 and later rediscovered in 1957 by J. Wallmark [6]. In the present section, we summarize important results from Ref. [7] and Ref. [8] with focus on the tetralateral photodiode which is the most common commercially available design.

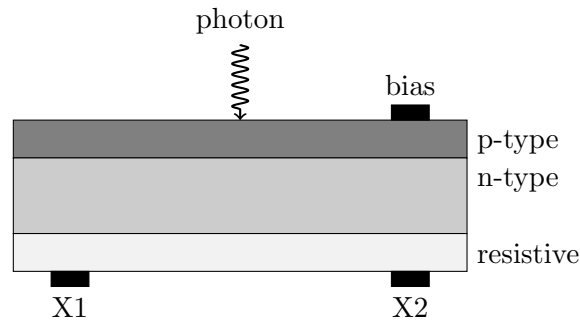


Figure 11: Cross section of a lateral photodiode.

Figure 11 depicts the cross-section of a lateral photodiode with a p-type semiconductor as the top, an n-type semiconductor as the middle layer and a resistive material as the bottom layer. An electric contact embedded into the top layer can be used as a common cathode. The common cathode can be connected to the ground or a positive voltage for reverse bias operation. In contrast to the transversal photodiode, the lateral photodiode has two anode contacts positioned at the opposite sites embedded into the resistive layer. The photocurrent measured at each of the anode contacts follows an almost linear relationship with the center-of-mass of the incident light spot. Therefore the lateral photodiode can be used to measure the spatial coordinate of an incident light spot.

The dynamics of the lateral photodiode are guided by the Lucovsky [9] equation,

$$\nabla^2 V = \frac{\rho}{w} J_s \left(e^{eV/k_B T} - 1 \right) - \frac{\rho_d}{w} J_p, \quad (7)$$

wherein V is the diode voltage, ρ is the resistance per unit length of the resistive layer, J_s is the reverse-bias saturation current and J_p is the photocurrent generated due photon induced electron-hole excitation. Equation (7) can be obtained by combination of the current density continuity equation with Ohm's law and the Schottky equation, Equation (4).

According to Ref. [8], operation of the lateral in fully reverse-bias has the following benefits:

1. Reduced signal loss.
2. Improved response speed and resolution.
3. Improved linearity of the position.
4. Reduced temperature dependence.

In electronic engineering literature, e.g. Ref. [10, p. 258], one is sometimes discouraged from operating a photodiode under reverse-bias for highest sensitivity as the reverse-bias increased the diode leakage (dark) current. We believe that as long as the dark current is significantly smaller than the typical photocurrent, the photodiode should always be operated in reverse-bias mode as recommended Ref. [7, 8, 11, 2].

Assuming a fully reverse-biased lateral photodiode, we have $eV/k_B T \ll 1$ and Equation (7) simplifies to a linear second order differential (Poisson) equation,

$$\nabla^2 V \approx -\frac{\rho}{w} (J_s + J_p), \quad (8)$$

which can be solved using variable separation and a product Ansatz. The solution of Equation (8) depends on the imposed boundary conditions. The Dirichlet boundary

condition, $V = 0$, should be used if an electrical contact terminates the semiconductor, otherwise, the Neumann boundary condition, $\frac{\partial V}{\partial n} = 0$, should be assumed.

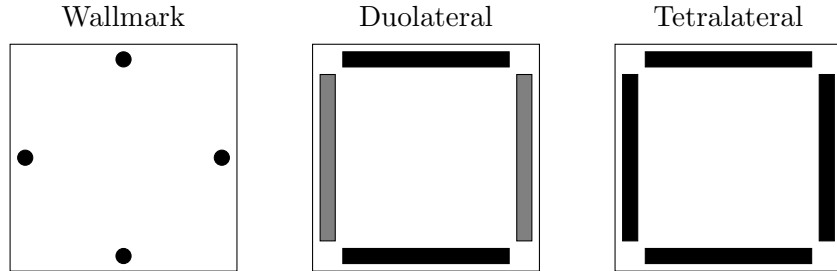


Figure 12: Contact configurations of a lateral photodiode.

In Figure 12 we present three different contact configurations. The left contact configuration was used by Wallmark [6] and comprises four small electronic contacts. Assuming that the contact size is small compared to the surface of the photodiode, the von Neumann boundary condition have to be used. The middle contact configuration receives great attention from Noorlag [7]. On two opposite sides of the photodiode an electric contact terminates the boundary while the remaining sides are left empty. For two-dimensional position detection, one can create two electric contacts at another layer. Mathematically we can express this configuration as combination of Neumann and Dirichlet boundary conditions. Finally, the tetralateral configuration where each side on the same layer is terminated by electric contacts can be modelled by Dirichlet boundary conditions on all sides. For a rectangular tetralateral photodiode of width l , the explicit boundary conditions are,

$$V(0, y) = V(l, y) = 0, \quad V(x, 0) = V(x, l) = 0. \quad (9)$$

Together with the initial condition that a focused light spot hits the photodiode at (x^*, y^*) ,

$$V_p(x, y, t = 0) = I_p \frac{\rho}{w} \delta(x - x^*) \delta(y - y^*), \quad (10)$$

the general solution of the Lucovsky equation, Equation (8), for the tetralateral configuration reads,

$$V_p^*(x, y) = I_p \frac{\rho}{w} \sum_{n \in \mathbb{Z}} \sum_{m \in \mathbb{Z}} \frac{\sin(m\pi x/l) \sin(m\pi x^*/l) \sin(n\pi y/l) \sin(n\pi y^*/l)}{(m^2 + n^2)\pi^2}. \quad (11)$$

The current that flows through the $x1$ contact is given by,

$$I_{x1}(x^*, y^*) = \frac{w}{\rho} \int_0^l dy \left. \frac{\partial V}{\partial x} \right|_{x=0}, \quad (12)$$

respective,

$$I_{x1}(x^*, y^*) = \frac{2}{\pi} I_p \sum_{n \in \mathbb{Z}} \frac{\sin[(2n-1)\pi y^*/l] \sinh[|2n-1|\pi(1-x^*/l)]}{2n-1 \sinh(|2n-1|\pi)}. \quad (13)$$

The solution does not disclose the linear relationship between anode current I_{x1} and the incident spot light coordinate x^* . Ref. [8, Fig. 7] renders the non-linear distortion close to the boundaries as described by Equation (13). In order to show analytically that there is an almost linear relationship between I_{x1} and x^* , we fix $y^* = l/2$, numerically evaluate the dominant terms and Taylor expand the terms to linear order,

$$I_{x1}(x^*, l/2) = \frac{2}{\pi} I_p \sum_{n \in \mathbb{Z}} \frac{(-1)^{n+1} \sinh(|2n-1|\pi(1-x^*/l))}{2n-1 \sinh(|2n-1|\pi)} \quad (14)$$

$$\approx I_p \left\{ 0.25 - 0.41731 \left(\frac{x}{2l} - 1 \right) \right\} + \mathcal{O} \left(\left(\frac{x^*}{l} - \frac{1}{2} \right)^2 \right). \quad (15)$$

Using the difference between two opposite contacts and normalizing for the total photocurrent, we find,

$$\frac{I_{x2}(x^*, l/2) - I_{x1}(x^*, l/2)}{I_{x1}(x^*, l/2) + I_{x2}(x^*, l/2)} \propto \frac{x}{l}, \quad (16)$$

which indeed is linear in x .

According to Ref. [7, p. 41], the tetralateral photodiode has benefits in manufacturing, although its linearity is below the duallateral photodiode, but still better than the Wallmark type, see Ref. [8]. Recent contact configurations have improved upon the tetralateral design in order to improve the linearity. For example, the commercially available pin-cushion tetralateral photodiode, discussed in Ref. [12, 11], shows good linearity over a large area. The center-of-mass of an incident light spot at (x^*, y^*) can be recovered from the anode currents via,

$$\frac{(I_{x2} + I_{y1}) - (I_{x1} + I_{y2})}{I_{x1} + I_{x2} + I_{y1} + I_{y2}} = \frac{2x^*}{l} \quad \frac{(I_{x2} + I_{y2}) - (I_{x1} + I_{y1})}{I_{x1} + I_{x2} + I_{y1} + I_{y2}} = \frac{2y^*}{l}. \quad (17)$$

The datasheet [13] of the S5990, a pin-cushion tetralateral photodiode, discloses the position detectability of a light spot of size 0.2 mm over a scan interval of 0.4 mm which does not show any non-linear distortion.

B.3. Equivalent circuit

In the previous section, we described the physics behind the lateral photodiode. In the current section, we want to ignore microscopic details and concentrate on the electrical properties of real tetralateral photodiodes.

In Figure 13 the equivalent circuit of a tetralateral photodiode is depicted. The tetralateral photodiode has four anode connections X1, X2, Y1, and Y2 which are connected to the junction via position-dependent resistances R_1 , R_2 , R_3 , and R_4 . The actual junction is equivalent to two current sources I_p , I_d , a resistor R_d , and a capacitor C_d in parallel. The first current source I_p represents the generated photocurrent with typical values between μA and mA . The second current source I_d represents the generated leakage or dark current with typical values between pA and nA .

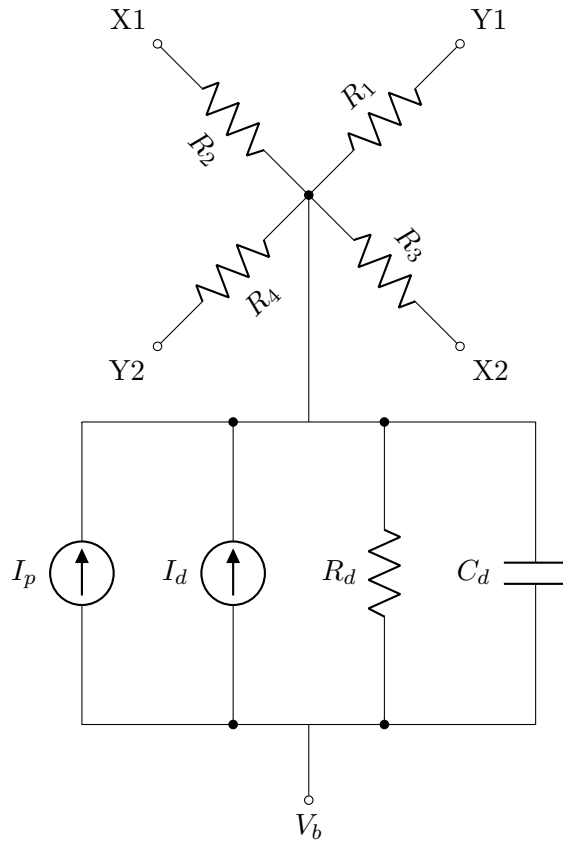


Figure 13: Equivalent circuit of a tetralateral photodiode.

The resistance R_d is referred to as interelectrode resistance and is about $10\text{ k}\Omega$. The capacitance C_d is also referred to as terminal capacitance and is about 150 pF . Resistance R_d and capacitance C_d form an RC pole which frequency is given by,

$$f_d = \frac{1}{2\pi R_d C_d}. \quad (18)$$

For $R_d = 10\text{ k}\Omega$ and $C_d = 100\text{ pF}$ the cut-off frequency f_d of the pole is about 1 MHz , representing the intrinsic bandwidth limit of the detector.

B.4. Signal-to-noise ratio

According to [8], the thermal (Johnson) noise of the resistive component of the lateral photodiode is the dominant noise source. The thermal noise is given by,

$$I_t = \sqrt{\frac{4k_B T B}{R}}, \quad (19)$$

wherein B denotes the bandwidth to consider. At room temperature $T = 300$ K and an interelectrode resistance of $R_d = 10$ k Ω , we find a noise current density due to thermal noise of $i_t = 2$ pA/ $\sqrt{\text{Hz}}$. If we estimate for the complete bandwidth supported by the detector we find a root-mean-squared noise current of $I_t = 2$ nA. A more realistic bandwidth incorporating later analog components would be $B = 10$ kHz, yielding $I_t = 200$ pA.

In any case, we cannot say for sure how these noise sources propagate into position detection noise. For instance, if the noise propagates in same proportions over the anodes, any error should cancel out when calculating the position. Further research has to be conducted.

C. Theory of operational amplifier

The photocurrents created by our detector are in the range of microampere where they are vulnerable to noise. Using a preamplifier, we can increase the amplitude of the signal for an improved signal-to-noise ratio. The typical photocurrent preamplifier is based on the transimpedance (current-to-voltage) amplifier design using a voltage-feedback operational amplifier. Converting the current to a voltage signal has the benefit that the voltage signal can be easily visualized with an oscilloscope. Furthermore, the voltage-feedback operational amplifier design appears to be more common than the current-feedback operational amplifier, as manufacturers offer much more choice and they are more prominent in the literature. That said, current-feedback operational amplifiers are reported to be a viable solution for high-speed and high-bandwidth applications, see Ref. [10, p. 110] for an overview of the benefits of current-feedback amplifiers and Ref. [14, Ch. 9] for a comparison with voltage-feedback amplifiers. An embodiment of current-feedback operational amplifiers for high-accuracy applications can be found in Ref. [7, p. 143].

In the following, we will always refer to the voltage-feedback operational amplifier if not noted otherwise. Moreover, we expect the reader to be familiar with the foundations of the operational amplifier. Well-written introductions to this topic can be found in [10, Ch. 1] and [14, Ch. 3].

C.1. Basic design

The basic design of a transimpedance amplifier is illustrated in Figure 14. Ignoring imperfections of the photodiode, we can represent the photodiode as a current source. The non-inverting input of the operational amplifier is connected to ground. The inverting input is coupled with the output of the operational amplifier via a feedback impedance Z_f .

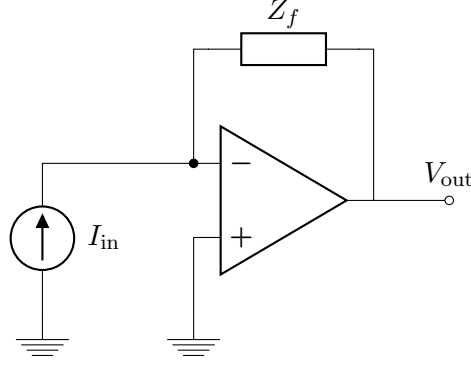


Figure 14: Basic transimpedance amplifier using voltage feedback operational amplifier.

The ideal operation amplifier has zero input current, thus, in the node of the inverting input of the operational amplifier Kirchhoff's law states that the current going through the feedback impedance has to cancel the current of the current source I_{in} . The current through the feedback impedance Z_f can be expressed in terms of the feedback impedance Z_f and the output voltage V_{out} of the operational amplifier through the use of Ohm's law, yielding,

$$V_{\text{out}} = -Z_f I_{\text{in}}. \quad (20)$$

Given a maximum current I_{in} and a desired maximum output voltage V_{out} , Equation (20) determines the feedback impedance. Limitations arise for real operational amplifiers where the output voltage is limited to be below the supply voltage of the operational amplifier.

Aside from photodiode applications, it is more common to find the inverting (voltage-to-voltage) operational amplifier in the literature. By using the source transformation on the current source with a parallel impedance in the transimpedance amplifier circuit, we can recover the inverting operational amplifier circuit, and thereby easily use results obtained for the inverting amplifier design.

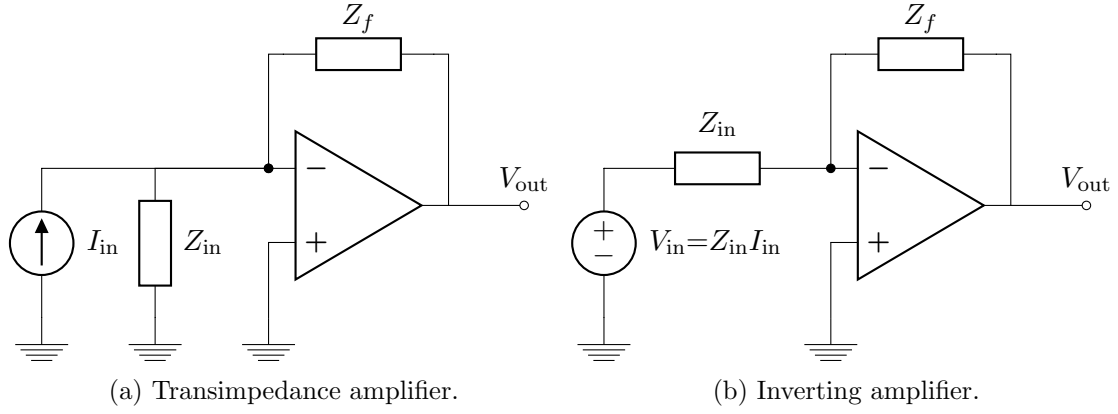


Figure 15: Equivalence between transimpedance and inverting amplifier using source transformation.

Figure 15 shows the source transformation applied to transimpedance and inverting amplifier circuits. Given a current source I_{in} with parallel impedance Z_{in} the equivalent voltage source has value $V_{in} = Z_{in}I_{in}$ with impedance Z_{in} in series.

C.2. Input offset voltage

Real operational amplifiers only reduce the voltage difference between the inverting and non-inverting input to a non-zero input offset voltage. For high-precision operational amplifiers, the input offset voltage is in the range of microvolts. We can model the input offset voltage as a voltage source at the non-inverting input of an ideal operational amplifier in our transimpedance circuit, as can be seen from Figure 16. In Figure 16 we amended the basic transimpedance circuit of Figure 14 by inserting a voltage source with the input offset voltage between the non-inverting input and ground.

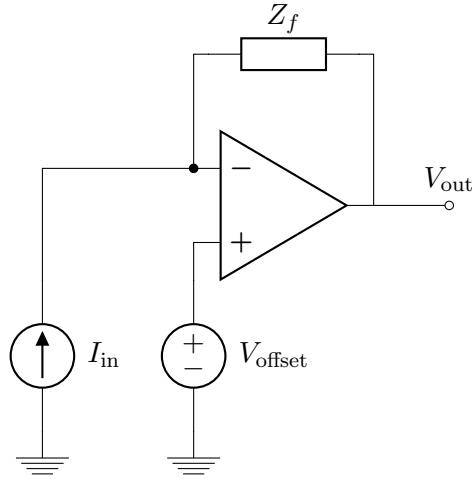


Figure 16: Input offset voltage in the transimpedance amplifier.

In order to estimate the output offset V_{out} caused by the input offset voltage V_{offset} we adapt the picture of the inverting amplifier. Figure 17 shows an inverting amplifier circuit with input impedance Z_{in} and input offset voltage V_{offset} at the non-inverting input of the operational amplifier. According to the superposition theorem, we can replace the input voltage source with a short circuit to estimate the contribution of the input offset voltage source.

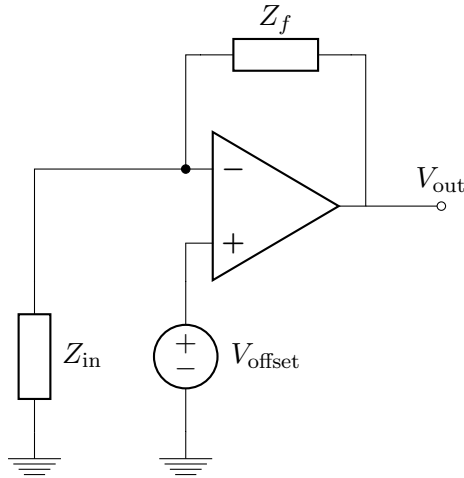


Figure 17: Input offset voltage in the inverting amplifier.

From Figure 17 we identify input and feedback impedance as a voltage divider in which

the input and output nodes are exchanged. The respective transfer function reads,

$$V_{\text{out}} = -\frac{R_f + R_{\text{in}}}{R_{\text{in}}} V_{\text{offset}} = -\left(1 + \frac{R_f}{R_{\text{in}}}\right) V_{\text{offset}}. \quad (21)$$

Comparing Equation (21) with Equation (20) discloses a difference in gain. The gain of the input signal in Eq. 1 is commonly referred to as signal gain. The gain of a signal applied directly to the inputs of the operational amplifier is referred to as noise gain. In the case of the position-sensitive detector, the input resistance is of order 10 k Ω . Using a feedback resistance of $R_f = 100$ k Ω we find that the input offset voltage experiences a gain of 11.

One approach to compensate for the input offset voltage as described is depicted in Figure 18, see also Ref [10, p. 54]. A potentiometer with maximum resistance R_p connects the positive and negative supply voltage. The wiper of the potentiometer is connected with a first resistor R_1 to a node. The node is connected with a second resistor R_2 and an optional bypass capacitor to ground. Finally, the equivalent input offset voltage source connects the node with the non-inverting input of the operational amplifier.

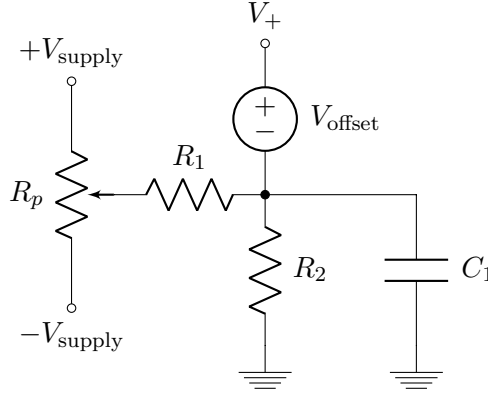


Figure 18: Input offset voltage compensation using adjustable potentiometer.

Let $0 \leq x \leq 1$ be the position of the potentiometer. For $x = 1/2$ the resistance of the potentiometer is $R_p/2$ and there is no offset compensation. For $x < 1/2$ the input offset compensation is negative to compensate for a positive input offset voltage. For $x > 1/2$ the input offset compensation is positive to compensate for a negative input offset voltage. The maximum input offset compensation is obtained for $x = 0$ and $x = 1$. Using circuit analysis techniques, we obtain,

$$V_c(x) = \frac{R_2(1 - 2x)}{R_1 + R_2 - R_p(1 - x)x} V_{\text{supply}}, \quad (22)$$

as an analytical expression for the input offset voltage compensation measured between the node and ground. The maximum absolute value of the compensation voltage follows

to be,

$$V_c(0) = V_c(1) = \pm \frac{R_2}{R_1 + R_2} V_{\text{supply}}. \quad (23)$$

Given a maximum input offset voltage of $100\text{ }\mu\text{V}$ and a supply voltage of 15 V , we find approximate resistor values $R_1 = 3\text{ M}\Omega$ and $R_2 = 2\text{ }\Omega$. The resistor value of the potentiometer R_p should be chosen sufficiently large such to limit the current. For example, a potentiometer resistance of $R_p = 15\text{ k}\Omega$ would limit the current to 2 mA with a heat dissipation of 60 mW . In practice, one should aim for a slightly higher maximum compensation voltage in order to handle resistor mismatches.

That said, there are some practical arguments against the use of the described input offset voltage compensation. The first argument is that the low resistance of R_2 acts as a dominant source for thermal current noise density of about $100\text{ pA}/\sqrt{\text{Hz}}$. As this current noise contributes to the input of the transimpedance amplifier it gets amplified by the feedback impedance Z_f , yielding up to $110\text{ }\mu\text{V}/\sqrt{\text{Hz}}$ in voltage noise density, which — depending on the bandwidth — surpasses the actual input offset voltage to compensate. The second argument is that high-precision potentiometers with large dynamic range get very large and difficult to accommodate on a printed circuit board.

C.3. Input bias current

In addition to the input offset voltage V_{offset} , there is a second effect that causes an offset in the output voltage V_{out} . This second effect stems from the small amount of current that is drawn from the inputs of the operational amplifier. We highlighted the input currents in Figure 19 where they are represented by the current flows i_+ and i_- directly pointing into the inputs of the operational amplifier in the transimpedance circuit.

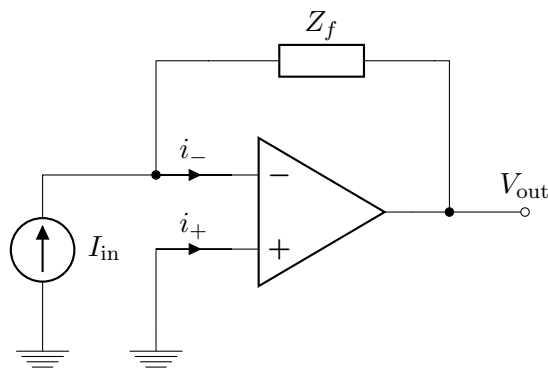


Figure 19: Input bias current offset in the transimpedance amplifier.

Input bias currents for high-precision operational amplifier are in the range of picoam-

peres. These small currents are usually difficult to measure and may differ between inputs. The datasheet of the operational amplifier, therefore, doesn't report the input bias current per terminal but the mean I_{bias} and the difference between the input currents I_{offset} . The relationship between the mean input bias current I_{bias} and the input offset current I_{offset} with respect to the actual input bias currents i_+ , i_- is given below.

$$i_+ = I_{\text{bias}} + \frac{1}{2}I_{\text{offset}} \quad I_{\text{offset}} = i_+ - i_- \quad (24)$$

$$i_- = I_{\text{bias}} - \frac{1}{2}I_{\text{offset}} \quad I_{\text{bias}} = \frac{i_+ + i_-}{2} \quad (25)$$

According to Ref. [10, p. 57] and Ref. [15, p. 25] the effect of the input bias currents i_+ , i_- on the output voltage V_{out} can be compensated with an impedance Z_c at the non-inverting input of the operational amplifier. Figure 20 illustrates the inverting amplifier configuration with such a compensation impedance Z_c .

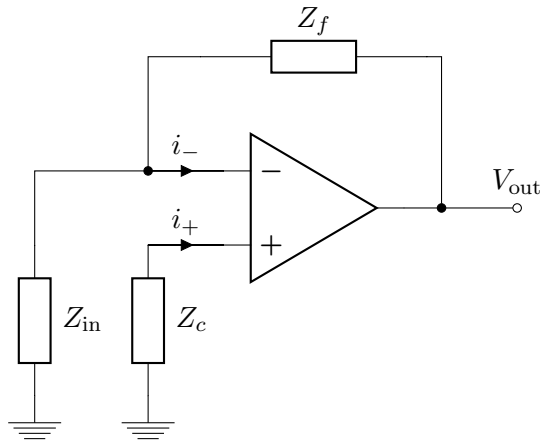


Figure 20: Input current offset compensation.

Following the argumentation from Ref. [16, p. 383], the input bias current at the inverting input of the operational amplifier i_- develops a voltage of $Z_f i_-$ over the feedback impedance Z_f . The input bias current at the non-inverting input i_+ develops the voltage $Z_c i_+$ over the compensation resistor Z_c . The voltage $Z_c i_+$ propagates through the voltage divider comprising the feedback and input impedance analogue to the input offset voltage. According to the superposition theorem, both of these contributions add and yield,

$$V_{\text{out}} = i_+ Z_c \left(1 + \frac{Z_f}{Z_{\text{in}}} \right) - i_- Z_f, \quad (26)$$

at the output voltage. If $i_+ \approx i_-$ we can choose,

$$Z_c = \frac{Z_{\text{in}}}{Z_{\text{in}} + Z_f}, \quad (27)$$

to compensate for the output voltage offset caused by the input bias currents. The condition $i_+ \approx i_-$ is usually satisfied if the input offset current I_{offset} reported in the datasheet is less than the mean input bias current I_{bias} . High-precision operational amplifier usually have compensated bias currents that do not satisfy this condition. In this case, there is no generic formula for the value of the compensation impedance Z_c in terms of input and feedback impedance and one needs to perform impedance matching on a per-device basis. One should keep in mind that high-precision operational amplifier have input bias currents in the range of pA. Using Equation (26) one should therefore first check if the output voltage offset due to input bias currents is even worth compensating compared to other offset and noise contributions.

C.4. Stability and bandwidth

The outputs of the transimpedance and inverting amplifier designs have a phase shift of 180° . If an additional phase shift of 180° accumulates because of the inherent bandwidth limitations of the operational amplifier and the gain is equal or greater than unity, the conditions for oscillations are met and the amplifier will become unstable, see Ref. [16, p. 395]. By artificially limiting the bandwidth with an additional frequency pole, we can flatten out the frequency response at high frequencies, and thereby stabilize the amplifier, see Ref. [17, p. 184].

Figure 21 shows a Bode plot of the open-loop (black) and noise gain (red) of an operational amplifier. The noise gain separates into a compensated (solid) and uncompensated (dotted) branch.

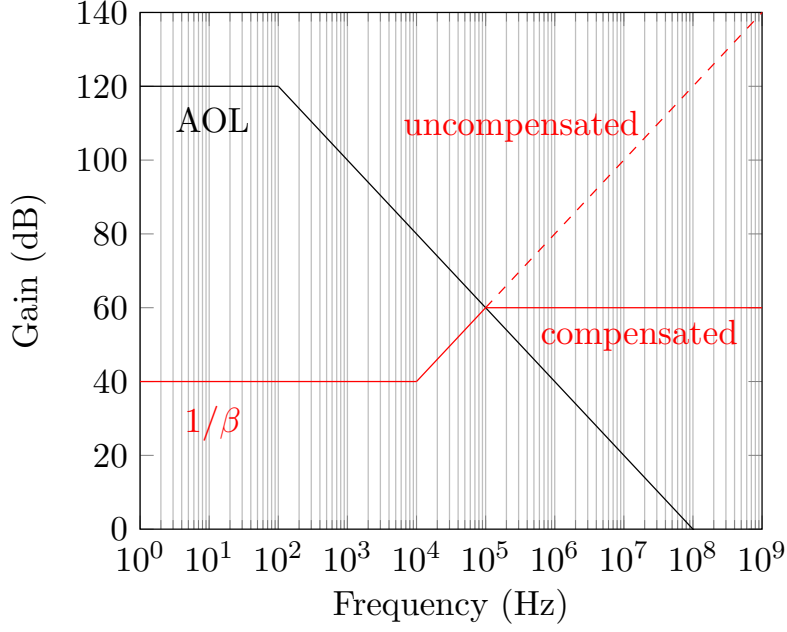


Figure 21: Bode plot of the open-loop and closed-loop gain of the amplifier.

With the uncompensated branch we would observe instability due to oscillations. The compensated branch is obtained through addition of a feedback capacitor. According to Ref. [10, p. 113], Ref. [2, p. 693] and Ref. [15, Ch. 3] the value for the feedback capacitance is given by,

$$C_f \geq \sqrt{\frac{C_{\text{in}}}{2\pi R_f f_u}}, \quad (28)$$

wherein R_f denotes the feedback resistance and f_u the unity-gain-bandwidth of the operational amplifier. The capacitance should be chosen larger to ensure design margin. The unity-gain-bandwidth of the operational amplifier denotes the frequency where the open-loop gain equals unity and is reported in the datasheet as gain-bandwidth-product (GBP) of the operational amplifier. C_{in} in Equation (28) represents the sum of the input capacities of the amplifier circuit and the capacitance of the signal source. According to Ref. [14, p. 185] a more exact formula for the feedback capacitance is given by,

$$C_f \geq \frac{C_{\text{aux}}}{2} \left(1 + \sqrt{1 + \frac{4C_{\text{in}}}{C_{\text{aux}}}} \right) \quad C_{\text{aux}} = \frac{1}{2\pi R_f f_u}, \quad (29)$$

which is also valid if not $C_{\text{in}} \gg C_f$.

Figure 22 illustrates the transimpedance amplifier with capacitive elements. Parallel to the current source I_{in} we find the input capacitance C_{in} comprising source capacitance

and operational amplifier capacitance. Parallel to the feedback resistance R_f we find the feedback capacitance C_f with value given in Equation (29) or Equation (28).

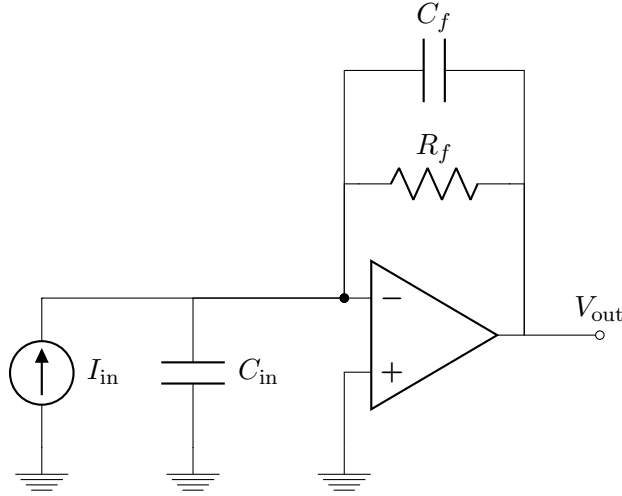


Figure 22: Transimpedance amplifier with capacitive elements.

As noted earlier, the bandwidth is reduced through the additional feedback capacitor. The new bandwidth is now given by the RC pole formed by the feedback impedance,

$$BW = \frac{1}{2\pi R_f C_f}. \quad (30)$$

Given a unity-gain-bandwidth of the operational amplifier of $f_u = 10$ MHz and a feedback resistance of $R_f = 100$ k Ω Equation (28) yields a minimum feedback capacitance of $C_f = 4$ pF. Together with R_f this feedback capacitance limits the bandwidth to about 400 kHz.

C.5. Signal-to-noise ratio

Glossary

GBP gain-bandwidth-product. 25

S5990 Hamamatsu two-dimensional PSD. 18

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